

Transmission microfocus X-ray module

FXE 160 micro



Stability equals precision

With its 15 W of transmission target power, you get a bright and highly resolving source for quick acquisition at high magnification. Proven Comet technology warrants stable operation at 160 kV allowing for the inspection of even complex multilayer parts. True X-ray Intensity - TXI, helps to deliver constant picture contrast resulting in a flicker-free acquisition that ensures the integrity of your inspection results.

Flexibility for a wider range of operation

You can't quantify what you can't see: With the Comet FXE you can detect, identify and measure features from a few milimeters to 2 µm. Combined with a high performing detector, this microfocus X-ray tube delivers superior analysis capability with a wide range of detail detection.

Unlimited lifetime

Our modular design facilitates quick replacement of critical parts, making the FXE's total cost of ownership among the lowest in its class. You'll never have to worry about running the tube at its limit, as you can always replace the wear-parts - even though the tube is designed to last, well beyond the expected life cycle of the module.

Easy to use for a faster workflow

Our user-friendly interface gives quick access to all major functions, including kV, tube current or target power, start-up routines, and focus adjustment. The Comet FXE is built to accelerate workflow creation for both you and your end-user.



The FXE module package

Microfocus X-ray tube

High power transmission target, active focus optics, a turbopump, vacuum sensor, and a serviceable beam chamber.

High voltage power supply

Power supply including a flexible HV cable with configurable length.

Control cabinet

PLC, safety circuitry, roughing pump, integrated cooler, power supply, and focusing optics control.

Integration tools

GUI for quick operation, including software libraries, and documentation for integration.

Spare parts

All parts of the FXE module can be replaced. Typical wear parts are filaments, emitter-units, X-ray targets, and O-rings.

Typical applications

Electronics inspection

- Soldering joints on circuit boards PCB
- Ball grid arrays BGA
- · Integrated circuits IC
- · Bonding wires

Semiconductor packaging and interconnects
Wafer-level chip-scale packages - WLCSP
Microelectromechanical systems - MEMS
Optical components
Battery cell inspection
Cables, conduits, and plastics
Small animal imaging
Soft tissue imaging and scaffolding
Medical implants and devices

Specifications

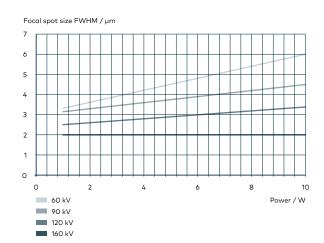
FXE-160.50

Specifications	1 XL-100.50
HV range	20 to 160 kV
Max. tube current	1000 μΑ
Max. tube power	64 W
Max. target power	15 W
Target	High power target
Permanent filtration	Carbon
Beam angle	1709
Min. focus object distance	< 300 μm
Max. resolution*	< 2 μm
Microfocus tube W, H, L **	183, 319, 505 mm
Weight	23 kg
HVPS W, H, L	210, 425, 534 mm
Weight	39 kg
High voltage cable	R24 Connectors
Diameter	29 mm
Bending radius, static / dynamic	60 / 120 mm
Control Cabinet W, H, L	800 * 1300 * 550 mm

^{*} JIMA RT RC-02B

Spot size

You can adjust the high voltage and target power to obtain a focal spot matching your inspection task.*



^{*} Typical focal spot sizes (full width half maximum) as a function of acceleration voltage as estimated based on best practices - no standards apply. Obtainable resolutions depend on system settings and cannot be warranted.

Herrengasse 10, 3175 Flamatt, Switzerland T +41 31 744 90 00 Web: xray.comet.tech Mail: mail.xray@comet.tech



^{**} STEP files available on request.